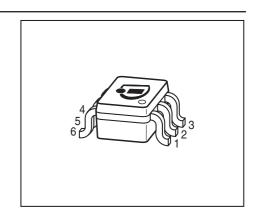


NPN Silicon RF Transistor

- For broadband amplifiers up to 1 GHz at collector currents from 1 mA to 20 mA
- BFS17S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFS17S	MCs	1=B1	2=E1	3=C2	4=B2	5=E2	6=C1	SOT363

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$	15	V
Collector-base voltage	V_{CBO}	25	
Emitter-base voltage	V_{EBO}	2.5	
Collector current	I _C	25	mA
Peak collector current, <i>f</i> = 10 MHz	I _{CM}	50	
Total power dissipation ¹⁾	P _{tot}	280	mW
<i>T</i> _S ≤ 93 °C			
Junction temperature	T_{J}	150	°C
Ambient temperature	T _A	-65 150	
Storage temperature	$T_{ m Stg}$	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	≤ 240	K/W

 $^{{}^{1}}T_{\rm S}$ is measured on the collector lead at the soldering point to the pcb

 $^{^2}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	·		•	•	
Collector-emitter breakdown voltage	V _{(BR)CEO}	15	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-base cutoff current	I _{CBO}				μΑ
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0		-	-	0.05	
$V_{\rm CB}$ = 25 V, $I_{\rm E}$ = 0		-	-	10	
Emitter-base cutoff current	I _{EBO}	-	-	100	
$V_{\rm EB}$ = 2.5 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}				_
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 1 V, pulse measured		40	_	150	
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 1 V, pulse measured		20	70	-	
Collector-emitter saturation voltage	V _{CEsat}	-	0.1	0.4	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1 mA					



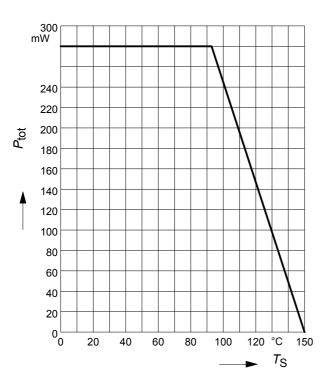
Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

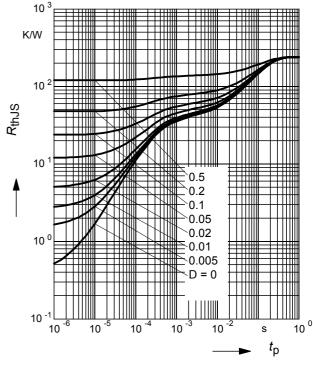
Parameter	Symbol	Values			Unit		
		min.	typ.	max.			
AC Characteristics (verified by random sampling)							
Transition frequency	f _T				GHz		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, f = 200 MHz		1	1.4	-			
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 5 V, f = 200 MHz		1.3	2.5	-			
Collector-base capacitance	C _{cb}	-	0.55	0.8	pF		
$V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,							
emitter grounded							
Collector emitter capacitance	C _{ce}	-	0.2	-			
$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,							
base grounded							
Emitter-base capacitance	C _{eb}	-	0.9	1.45			
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$,							
collector grounded							
Minimum noise figure	NF _{min}	-	3	5	dB		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = 50 Ω ,							
f = 800 MHz							
Transducer gain	S _{21e} ²	-	14	-	dB		
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,							
f = 500 MHz							
Third order intercept point at output	IP ₃	-	22.5	-	dBm		
V_{CE} = 5 V, I_{C} = 20 mA, f = 800 MHz,							
$Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt}$							
1dB compression point	P _{-1dB}	-	11	-	-		
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,							
f = 800 MHz							



Total power dissipation $P_{tot} = f(T_S)$

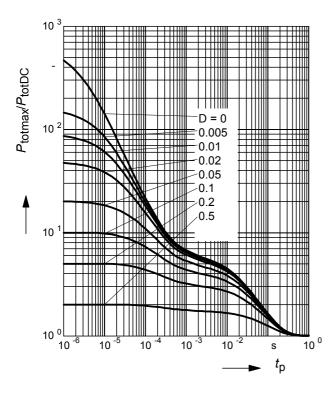
Permissible Pulse Load $R_{thJS} = f(t_p)$



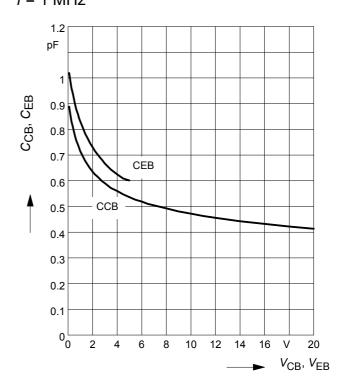


Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$



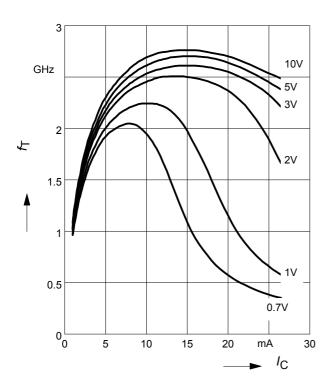
Collector-base capacitance $C_{cb} = f(V_{CB})$ Emitter-base capacitance $C_{eb} = f(V_{EB})$ f = 1 MHz





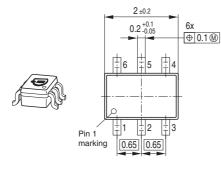
Transition frequency $f_T = f(I_C)$

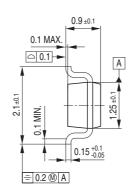
 V_{CE} = parameter



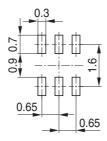


Package Outline



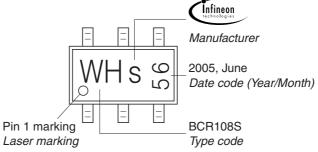


Foot Print



Marking Layout (Example)

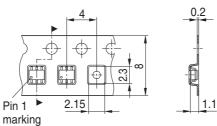
Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.





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